



Electron Beam Lithography @NanoMicroFab: a powerful tool for research and industrial applications

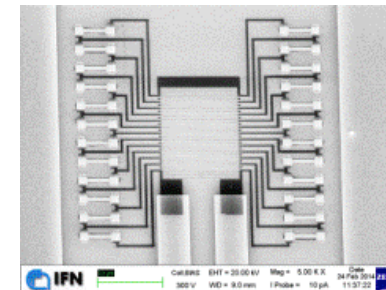
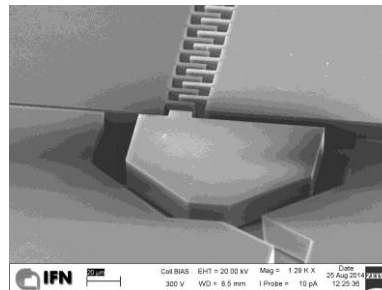
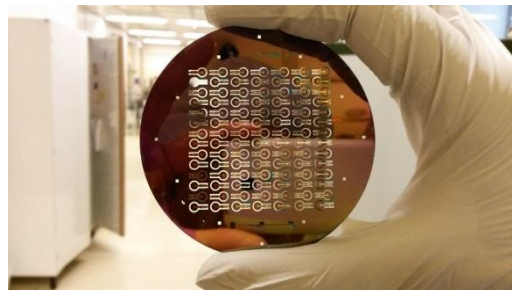
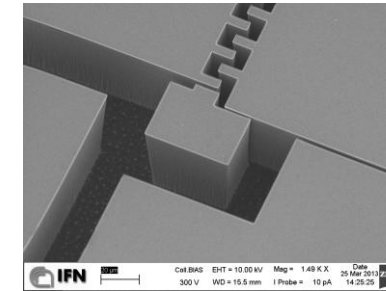
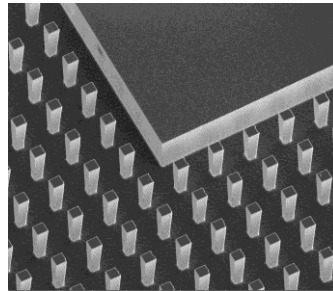
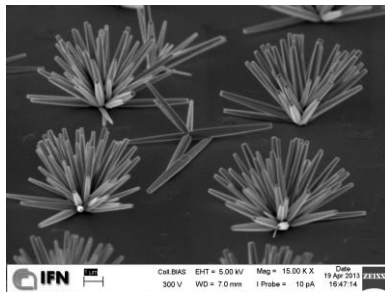


Annamaria Gerardino (CNR IFN Roma)



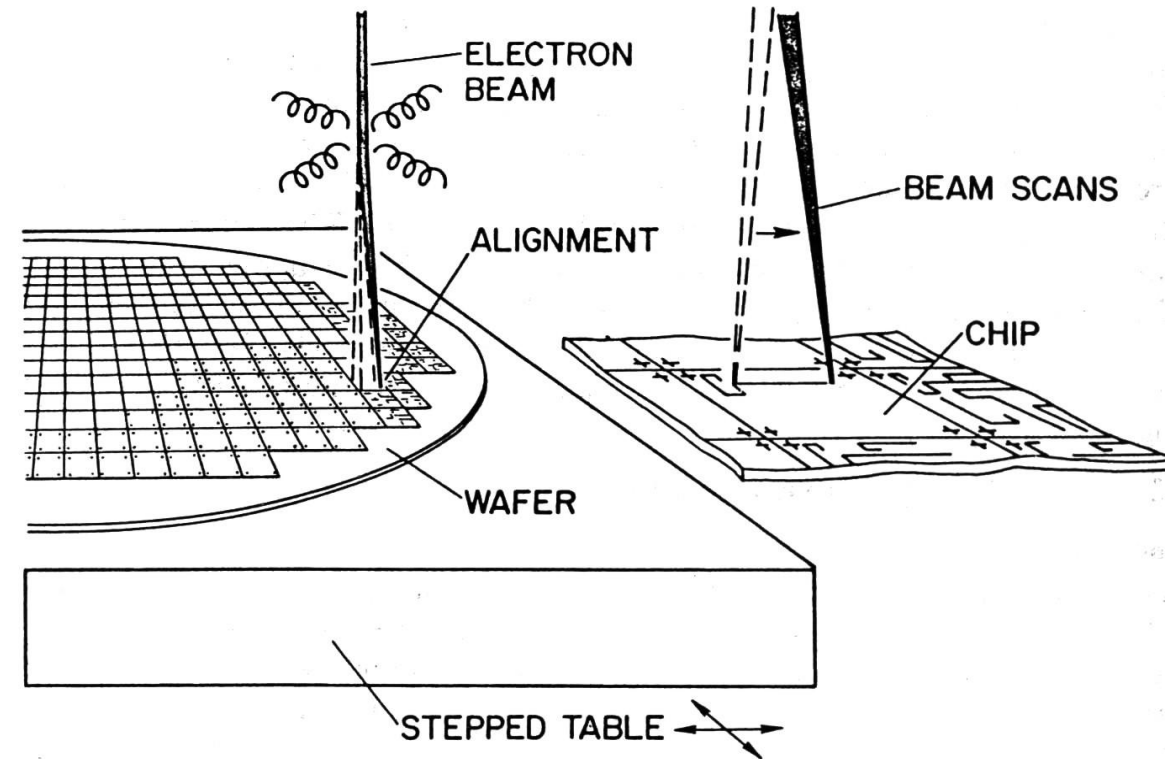
E-beam lithography is a tool for **microelectronics, photonics and nanotechnology** in general:

- Direct writing for advanced prototyping of integrated circuits (photonics on GaAs and Si, waveguides, T-gates, etc)
- Research into the scaling limits of integrated circuits and studies on quantum effects and other novel physics at very small dimensions (single electron transistor, quantum wires, finFET, single photon sources, qubits, etc)
- Mask-making, typically chrome-on-glass masks for optical lithography





- The e-beam is directed onto a substrate coated with an electronic resist
- The e-beam is deflected to direct write the chosen pattern
- The main deflection is linked to the acceleration voltage and defines writing field of fixed area



- To write on bigger areas, the stage moves; this movement is controlled by laser interferometer (resolution some nms)



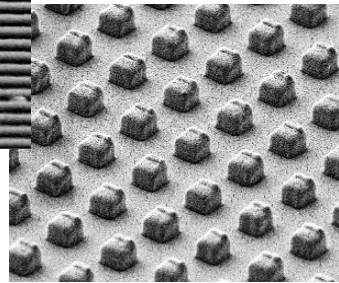
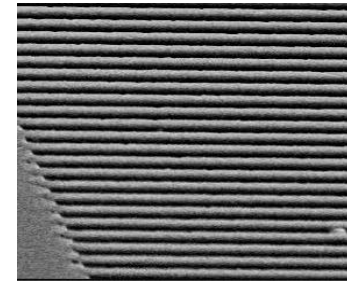
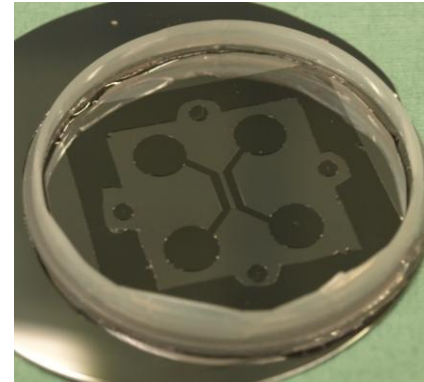
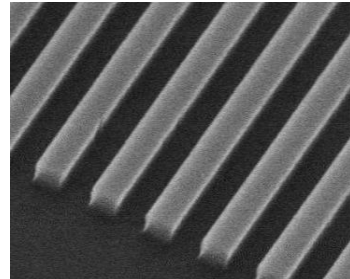
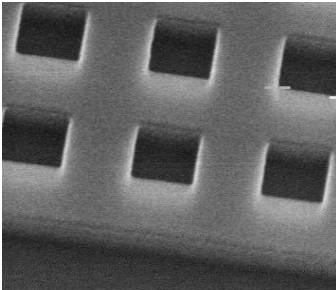
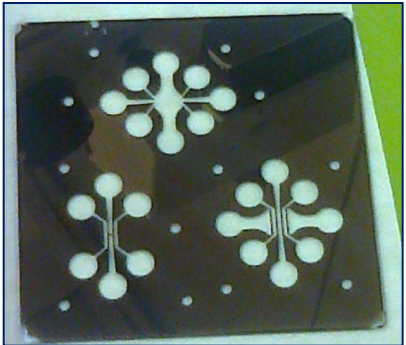
EBL



Serial
(pixel per pixel)



Slow but flexible



Optical and
Xray litho
Nanoimprint

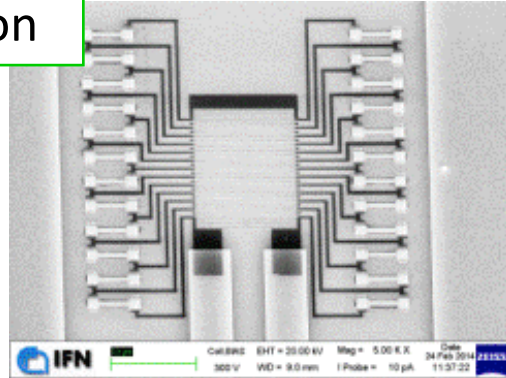
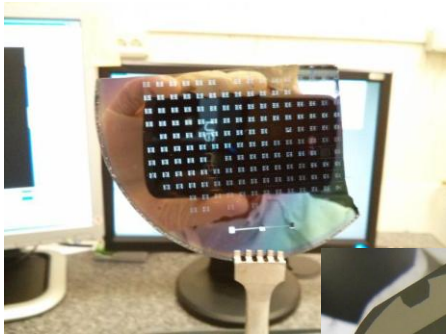


parallel
Needs MASKs
Needs template

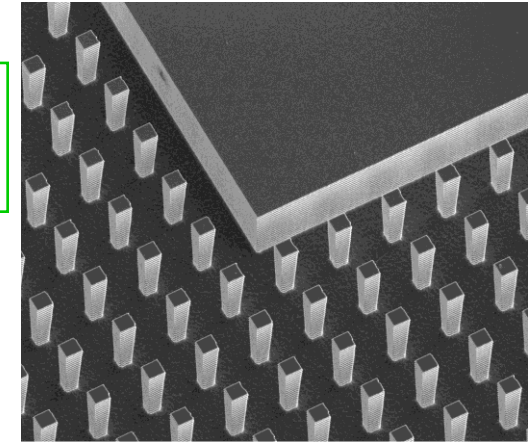


High Throughput
but fixed pattern

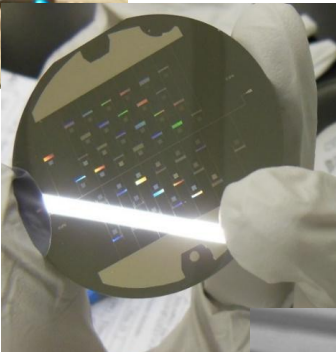
Micro&Nano fabrication



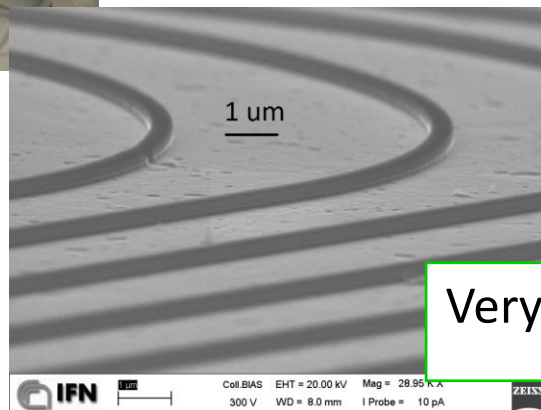
Thin film & micromachining



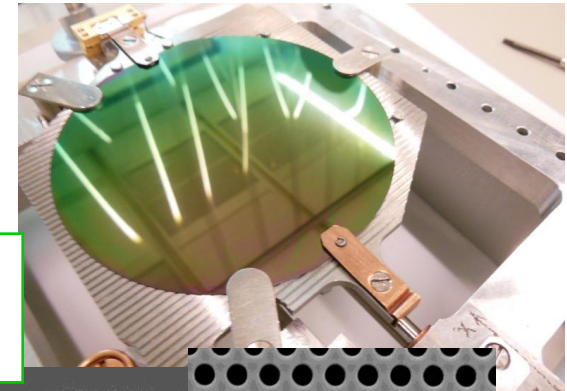
Long time know-how



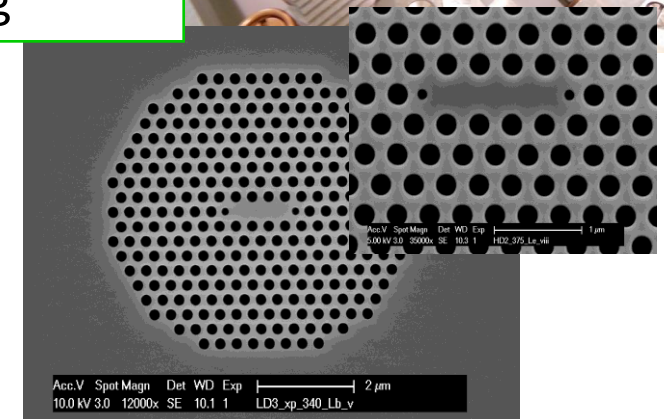
High flexibility in processes and procedures



Single devices & large area processing



Very different applications!!!



The first e-beam lithography machines, based on scanning electron microscope (SEM), were developed in the late 1960s. Shortly thereafter came the discovery that the common PMMA (polymethyl methacrylate) made an excellent electron beam resist.



1985 IESS (Istitute of Solid State Electronics)

LEICA Electron Beam Mask Fabricator

EBMF-10 First e-beam system installed in Italy in a research center.

LaB6 source

50kV (20kV upgraded)

beam 50nm

PDP 11 computer control

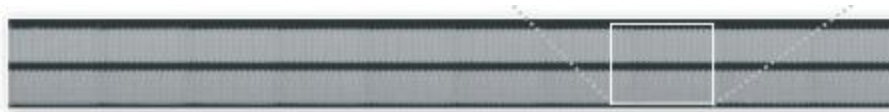
Dismissed in 2004

Raith-Vistec EBPG 5HR
Installed in 2004 @CNR IFN



- field emission gun FEG
- 100kV
- beam diameter: 8 nm
- 10 MHz frequency
- block size 560 μ m
- laser interferometer ($\lambda/120 \sim 5$ nm)
- Hight sensor
- overlay accuracy <20nm
- direct writing (up to 4")
- mask fabrication (up to 4")
- current: 0,1-100nA

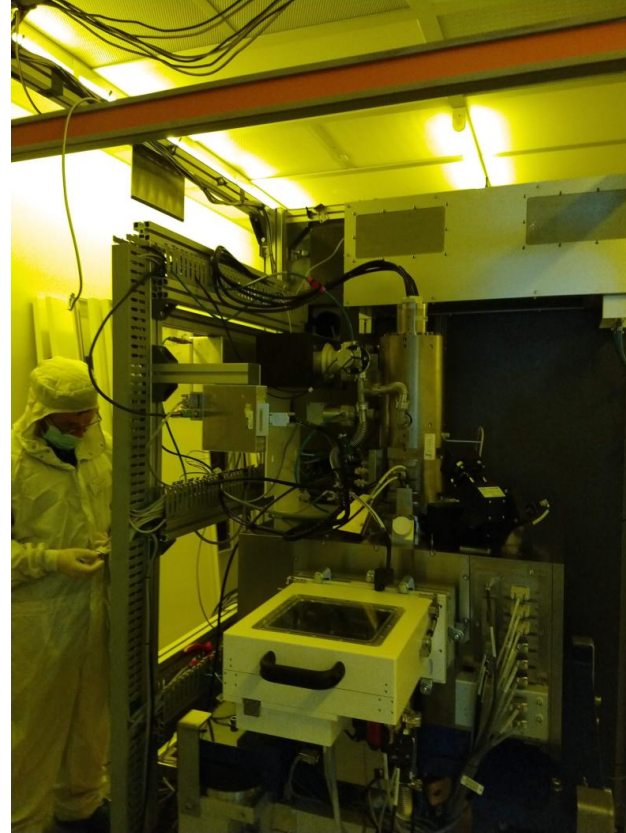
RAITH VOYAGER installed in July 2020
@NanoMicroFab



- 50 kV FEG
- Step frequency max. 50 MHz
- Minimum linewidth: <8 nm
- Mask fabrication up to 6"
- direct writing up to 6"
- Sample loading up to 8"

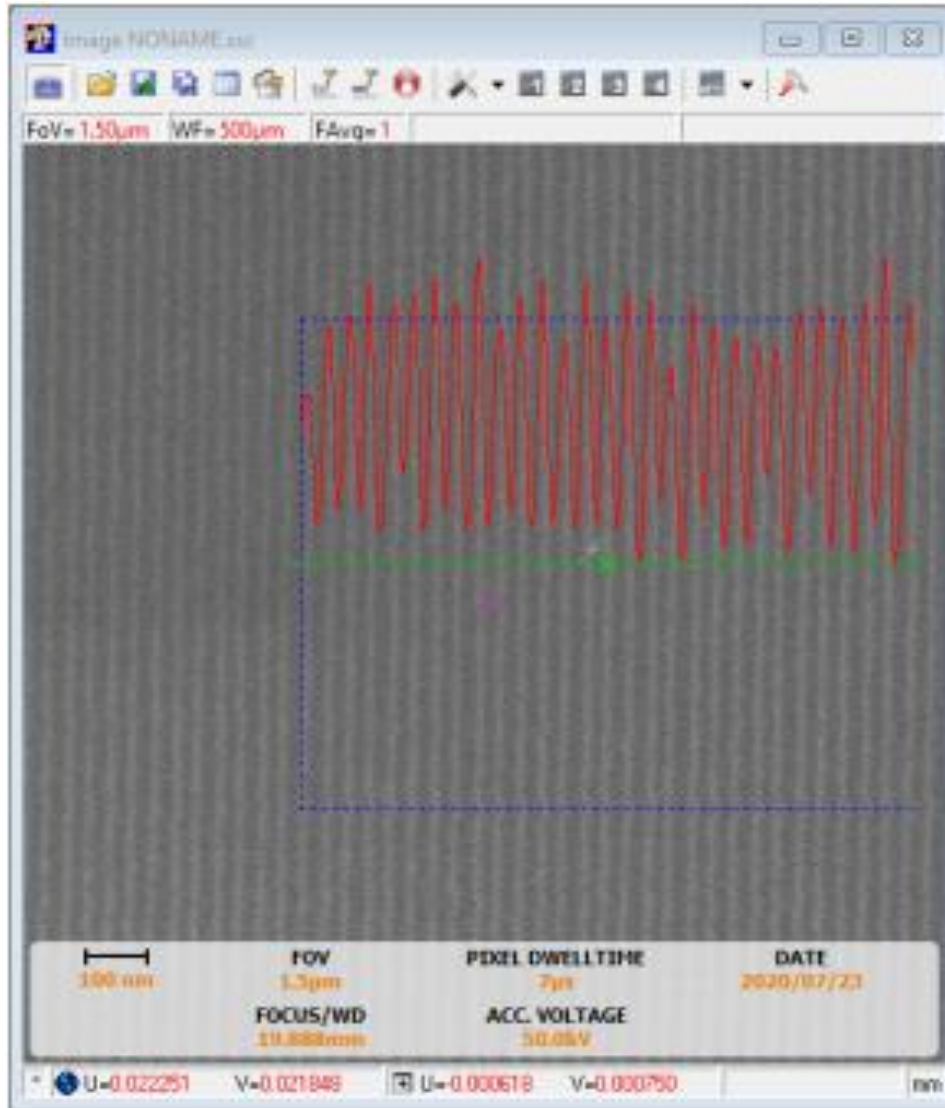
INSTALLATION

ELECTRON-BEAM LITHOGRAPHY

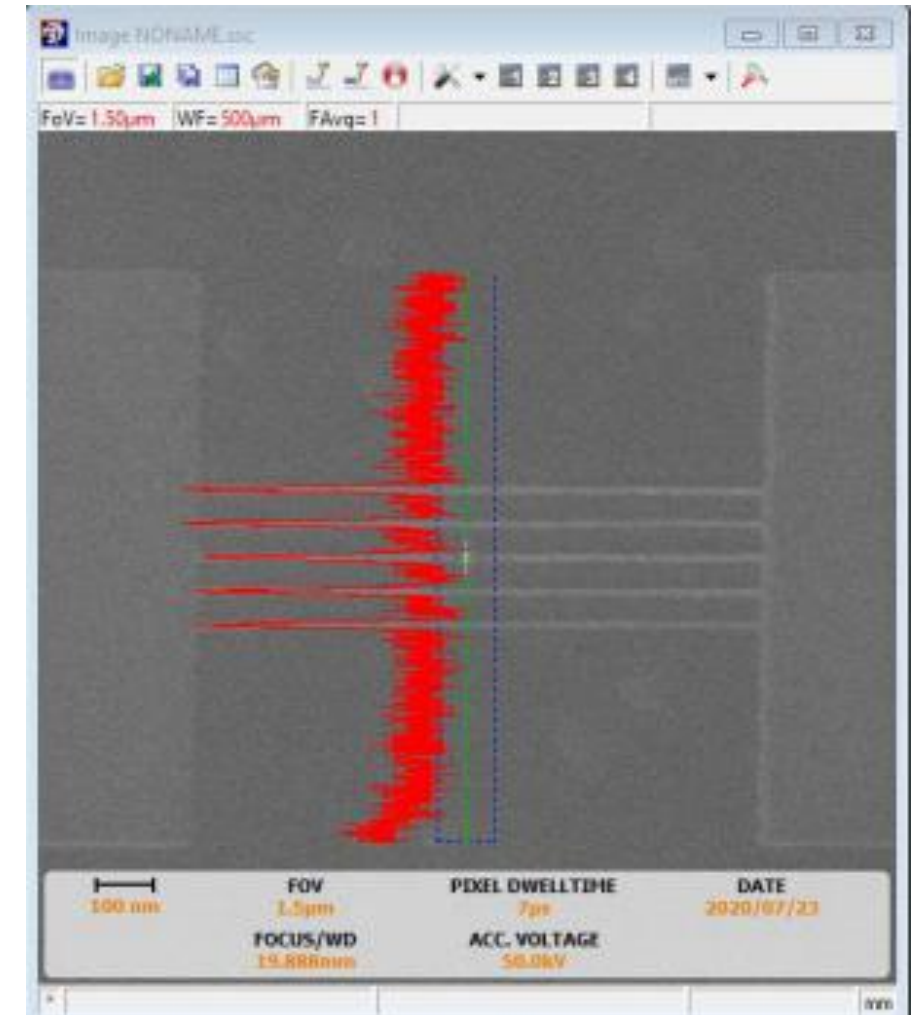


QUALIFICATION TEST

High resolution
result imaged in the
VOYAGER at 50kV.
PITCH: 35 nm; line: 15
nm



Result of the
smallest linewidth
test imaged in the
VOYAGER at 50kV.





Quantum/
photonics

RESOLUTION DOWN
TO FEW NM

Detectors

PROTOTYPING; MIX AND MATCH PROCESSES;
HIGH POSITIONING PRECISION; FLEXIBILITY

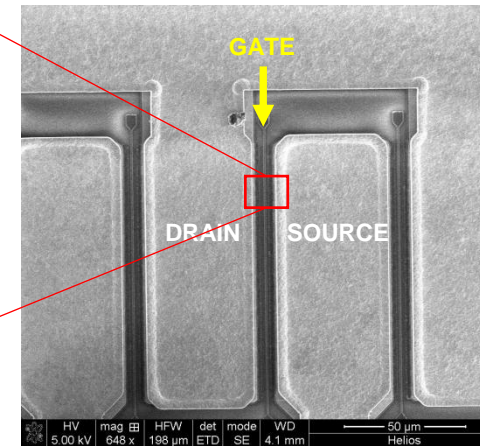
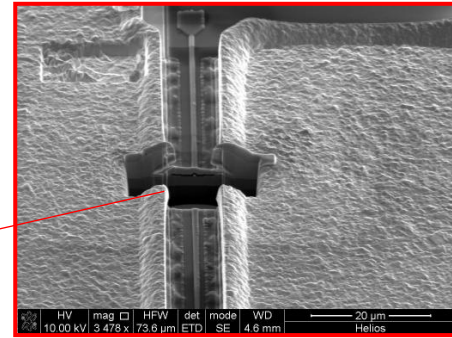
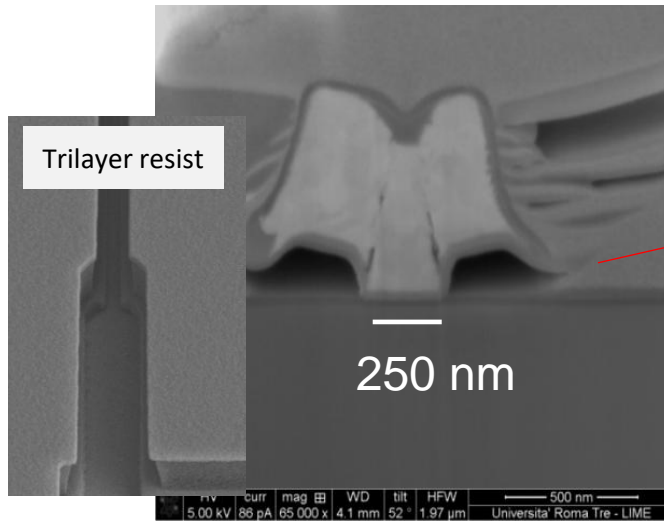
Sensors

Bio

LAB ON CHIP; POINT OF
CARE; MICROFLUIDICS

User oriented

Technology Transfer



HEMT high power amplifiers and/or low noise amplifier for radar applications

T-gate with $L_g = 250\text{nm}$

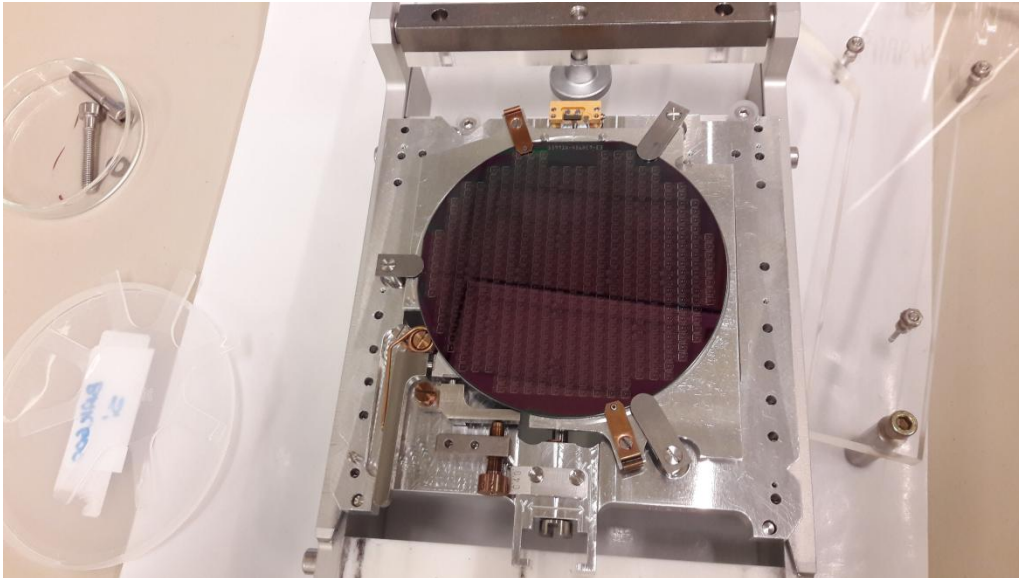
Single e-beam writing

- Trilayer PMMA/COP33/COP8
- EBL
- Development and metallization

- **Collaboration with Leonardo Company**
- **Technology transfer**
- **EBL used as SLX standard process in field-plate technology $L_g=250\text{nm}$**



- EBPG 5200ES is now in production line
- Totally dedicated to production
- R&D is developed @IFN CNR



THANK YOU FOR ATTENTION!

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